

ABSTRACT

The purpose of the present invention is to provide a liquid crystal sealing material for use in a liquid crystal drop fill method. The sealing material can achieve a rapid thermal reaction, rarely contaminates a liquid crystal throughout the process, and exhibits excellent storage stability and excellent cured product properties such as moisture proof reliability. The liquid crystal sealing material is characterized by comprising (a) one or more curable resins selected from among epoxy resins, (meth)acrylated epoxy resins, and partially (meth)acrylated epoxy resins, each resin bearing active hydrogen in the molecule (with the proviso that the active hydrogen is exclusive of hydrogen contained in a hydroxy group), and (b) a heat-curing agent.